

PROCEEDINGS OF SPIE

# ***Infrared Technology and Applications XLII***

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**18–21 April 2016  
Baltimore, Maryland, United States**

*Sponsored and Published by*  
SPIE

**Volume 9819**

Proceedings of SPIE 0277-786X, V. 9819

SPIE is an international society advancing an interdisciplinary approach to the science and application of light.

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Please use the following format to cite material from this book:

Author(s), "Title of Paper," in *Infrared Technology and Applications XLII*, edited by Bjørn F. Andresen, Gabor F. Fulop, Charles M. Hanson, Paul R. Norton, Proceedings of SPIE Vol. 9819 (SPIE, Bellingham, WA, 2016) Six-digit Article CID Number.

ISSN: 0277-786X  
ISSN: 1996-756X (electronic)  
ISBN: 9781510600607

Published by

**SPIE**

P.O. Box 10, Bellingham, Washington 98227-0010 USA  
Telephone +1 360 676 3290 (Pacific Time)- Fax +1 360 647 1445  
SPIE.org

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Printed in the United States of America Vm7 i ffUb '5gg: WjUH'gž bWzi bXYf`jW'bgY 'Zca 'GD9.

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